Form PTQ-1595 (Rev. 03-11) QMB No. 0651-0027 (exp. 03/31/2012)	U.S. DEPARTMENT OF COMMERCE United States Patent and Tradomark Office		
RECORDATION FORM COVER SHEET			
PATENTS ONLY			
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.			
Name of conveying party(les):	2. Name and address of receiving party(les)		
Hiroaki Fujli (04/23/2012), Satoshi Mukoyama (04/23/2012), Soya Araki (04/24/2012), Hisanori Tsuboi (04/24/2012), and Additional name(s) of conveying party(les) attached?	Name: Sony Corporation Internal Address: Street Address:		
3. Nature of conveyance/Execution Date(s):	1-7-1 Konan, Minato-ku		
Execution Date(s): In parentheses after inventor name X Assignment Merger Change of Name Security Agreement Joint Research Agreement	Tokyo 108-0075 JAPAN		
	City:		
Government Interest Assignment	Stale:		
Executive Order 9424, Confirmatory License Other	Country; Zlp: Additional name(s) & address(es) Yes X No attached?		
A. Patent Application No.(s) 13/470,528	This document is being filed together with a new application. B. Petent No.(s)		
Additional numbers attached? 5. Name and address to whom correspondence	6, Total number of applications and		
concerning document should be mailed: Name: Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00		
Internal Address: Atty, Dkt.: SONYJP 3.0-2784			
Street Address: 600 South Avenue West	Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)		
City: Westfield	8. Payment Information		
State: NJ Zip: 07090			
Phone Number: 908-654-5000			
Fax Number: 908-654-7866	Deposit Account Number 12-1095		
Email Address: ataylor@ldlkm.com	Authorized User Name Dennis M. Smid, Esq.		
9. Signature:	May 14, 2012		
Signature	Date Table number of pages including course		
Dennis M. Smid, Esq 34,930 Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:		

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PATENT REEL: 028206 FRAME: 0772

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RECORDATION FORM COVER SHEET (PTO-1595) (supplemental sheet)			
Additional Convey	/ing Party(ies)/Execu	tion Date(s) (1. Continued):	
Hidetomo Miyake (04	/25/2012)		
Additional Assign	ees (2. Continued):		
Assignee Name:			
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City:	State:	Country:	Zlp:
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Street Address:			
City:	State:	Country:	Zlp:
Assignee Name:			
Internal Address:			
Street Address:			
City:	State:	Country:	Zip:
Additional Applica	ations and/or Patents	(4. Continued):	
Additional Patent Applicat 4A. Continued:	ion Numbers	Additional Patent Numbers 48. Continued:	
	Additional numbers a	attached? Yes No	

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Docket No.: SONYJP 3.0-2784

REEL: 028206 FRAME: 0773

Attorney Docket No. SONYJP 3.0-2784 SONY Ref. No.: SP332730US00

ASSIGNMENT

WHEREAS. It as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DISPLAY

LDLKM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. It as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American Convention Relating to Patents. Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto:

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall be reafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto:

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insent the serial number and filing date of this application in the spaces that follow: Serial Number: 13/470, 528 Filing Date: May 14, 2012 Filing Date: This assignment executed on the dates indicated below. HIROAKI FUJII Name of first or sole inventor Execution date of U.S. Patent Application KANAGAWA, JAPAN Residence of First or sole inventor
Linoali Fojii Date of this assignment Signature of first or sole inventor SATOSHI MUKOYAMA Execution date of U.S. Patent Application Name of second inventor TOKYO, JAPAN Residence of second inventor

Signature of second inventor APH 23 20/2 Date of this assignment **SOYA ARAKI** Execution date of U.S. Patent Application Name of third inventor KANAGAWA, JAPAN Residence of third inventor April 24.2012

Date of this assignment toga arani Signature of third inventor

> PATENT REEL: 028206 FRAME: 0774

HISANORI TSUBOI

Attorney Docket No. SONYJP 3.0-2784 SONY Ref. No.: SP332730US00

ADDITIONAL INVENTOR(S)

LDLKM

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Name of fourth inventor	Execution date of U.S. Patent Application	
KANAGAWA, JAPAN	••	
Residence of fourth inventor		
	Date of this assignment	
Signature of fourth inventor	N P 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Signature of fourth inventor	Date of this assignment	
HIDETOMO MIYAKE		
Name of fifth inventor	Execution date of U.S. Patent Application	
	Execution date of O.S. I atom Application	
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Residence of fifth inventor	A N 35	
Hidetomo Miyake Signature of fifth inventor	Date of this assignment	
Signature of fifth inventor	Date of this assignment	
<u>.</u>	•	
Name of sixth inventor	Execution date of U.S. Patent Application	
Residence of sixth inventor		
Signature of sixth inventor	Date of this assignment	
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Name of seventh inventor	Execution date of U.S. Patent Application	
Residence of seventh inventor		
Signature of seventh inventor	Date of this assignment	
Signature of seventil inventor	Date of this assignment	
Name of eighth inventor	Execution date of U.S. Patent Application	
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Name of ninth inventor	Execution date of U.S. Patent Application	
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Residence of ninth inventor		
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Signature of ninth inventor	Date of this assignment	

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PATENT REEL: 028206 FRAME: 0775